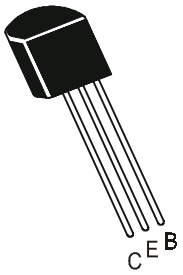
NPN SILICON PLANAR EPITAXIAL RF TRANSISTORS

BF494
BF495



TO-92
Plastic Package

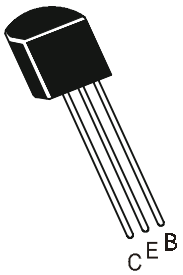
High Voltage Video Transistors

ABSOLUTE MAXIMUM RATINGS(Ta=25ºC unless specified otherwise)

DESCRIPTION	SYMBOL	Value	UNITS
Collector Emitter Voltage	V_{CEO}	20	V
Collector Base Voltage	V_{CBO}	30	V
Emitter Base Voltage	V_{EBO}	5	V
Collector Current (DC)	I_C	30	mA
Collector Current(peak value)	I_{CM}	30	mA
Total Power dissipation up to Tamb = 25ºC	P_{tot}	300	mW mW/ºC
Operating And Storage Junction Temperature Range	T_j, T_{stg}	-55 to +150	ºC
THERMAL RESISTANCE			
Junction to ambient	$R_{th(j-a)}$	420	K/W

ELECTRICAL CHARACTERISTICS (Ta=25ºC Unless Otherwise Specified)

DESCRIPTION		SYMBOL	TEST CONDITION	Min	Max	UNITS
Collector Cut- off Current		I_{CBO}	V_{CB}=20V,I_E=0		500	nA
Collector Cut - off Current		I_{CBO}	V_{CB}=20V,I_E=0			
			Ta =150 ºC		4.0	µA
EmitterCut off Current		I_{EBO}	V_{EB}=4V, I_C=0		500	nA
Base Emitter Voltage		$V_{BE(ON)}$	V_{CE}=10V,I_C=1mA	0.65	0.74	V
DC Current Gain						
	BF494	h_{FE} *	I_C=1mA,V_{CE}=10V	67	221	
	BF494A			200	500	
	BF494B			110	215	
	BF 495			35	125	
	BF 495C			65	135	
	BF 495D			40	85	



TO-92
Plastic Package

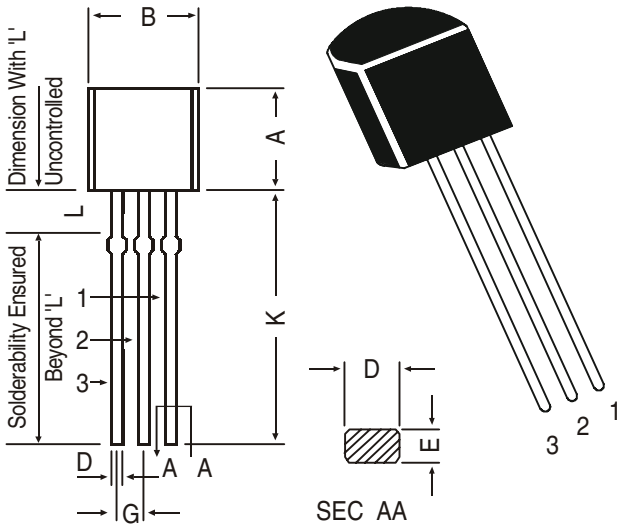
ELECTRICAL CHARACTERISTICS (Ta=25ºC Unless Specified Otherwise)

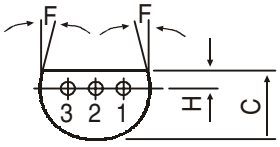
DESCRIPTION	SYMBOL	TEST CONDITION	Min	Max	UNITS
DYNAMIC CHARACTERISTICS					
Transition Frequency	f_T	I_C=1mA, V_{CE}=10V	120		MHz
Feedback Capacitance	C_{re}	V_{CE}=10V, I_C=1mA f=4.5MHz		1.0	pF

***V_{BE} decreases by about 1.7mV/K with increasing temperature.**

TO-92 Plastic Package

TO-92 Transistors on Tape and Ammo Pack

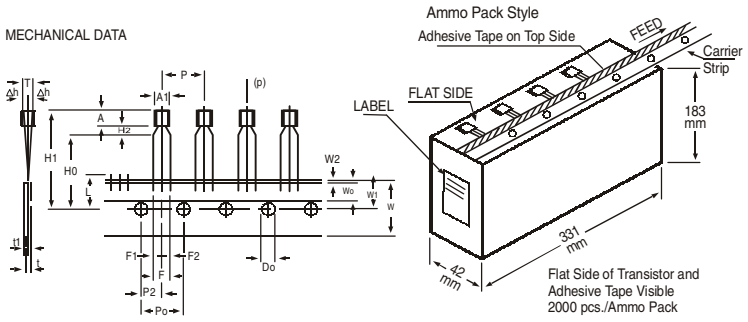




PIN CONFIGURATION
1. BASE
2. EMITTER
3. COLLECTOR

DIM	MIN.	MAX.
A	4.32	5.33
B	4.45	5.20
C	3.18	4.19
D	0.41	0.55
E	0.35	0.50
F	5 DEG	
G	1.14	1.40
H	1.14	1.53
K	12.70	—
L	1.982	2.082

All diminsions in mm.



All dimensions in mm unless specified otherwise

ITEM	SYMBOL	SPECIFICATION				REMARKS
		MIN.	NOM.	MAX.	TOL .	
BODY WIDTH	A1	4.0		4.8		
BODY HEIGHT	A	4.8		5.2		
BODY THICKNESS	T	3.9		4.2		
PITCH OF COMPONENT	P		12.7		±1	
FEED HOLE PITCH	Po		12.7		±0.3	CUMULATIVE PITCH ERROR 1.0 mm/20 PITCH
FEED HOLE CENTRE TO COMPONENT CENTRE	P2		6.35		±0.4	TO BE MEASURED AT BOTTOM OF CLINCH
DISTANCE BETWEEN OUTER LEADS	F		5.08		+0.6 -0.2	
COMPONENT ALIGNMENT	△h		0	1		AT TOP OF BODY
TAPE WIDTH	W		18		±0.5	
HOLD-DOWN TAPE WIDTH	Wo		6		±0.2	
HOLE POSITION	W1		9		+0.7 -0.5	
HOLD-DOWN TAPE POSITION	W2		0.5		±0.2	
LEAD WIRE CLINCH HEIGHT	Ho		16		±0.5	
COMPONENT HEIGHT	H1			23.25		
LENGTH OF SNIPPED LEADS	L			11.0		
FEED HOLE DIAMETER	Do		4		±0.2	
TOTAL TAPE THICKNESS	t			1.2		t1 0.3 - 0.6
LEAD - TO - LEAD DISTANCEF1,	F2		2.54		+0.4 -0.1	
CLINCH HEIGHT	H2			3		
PULL - OUT FORCE	(P)	6N				

NOTES
1. MAXIMUM ALIGNMENT DEVIATION BETWEEN LEADS NOT TO BE GREATER THAN 0.2 mm.
2. MAXIMUM NON-CUMULATIVE VARIATION BETWEEN TAPE FEED HOLES SHALL NOT EXCEED 1 mm IN 20 PITCHES.
3. HOLDDOWN TAPE NOT TO EXCEED BEYOND THE EDGE(S) OF CARRIER TAPE AND THERE SHALL BE NO EXPOSURE OF ADHESIVE.
4. NO MORE THAN 3 CONSECUTIVE MISSING COMPONENTS ARE PERMITTED.
5. A TAPE TRAILER, HAVING AT LEAST THREE FEED HOLES ARE REQUIRED AFTER THE LAST COMPONENT.
6. SPLICES SHALL NOT INTERFERE WITH THE SPROCKET FEED HOLES.

Packing Detail

PACKAGE	STANDARD PACK		INNER CARTON BOX		OUTER CARTON BOX		
	Details	Net Weight/Qty	Size	Qty	Size	Qty	Gr Wt
TO-92 Bulk	1K/polybag	200 gm/1K pcs	3" x 7.5" x 7.5"	5K	17" x 15" x 13.5"	80K	23 kgs
TO-92 T&A	2K/ammo box	645 gm/2K pcs	12.5" x 8" x 1.8"	2K	17" x 15" x 13.5"	32K	12.5 kgs

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